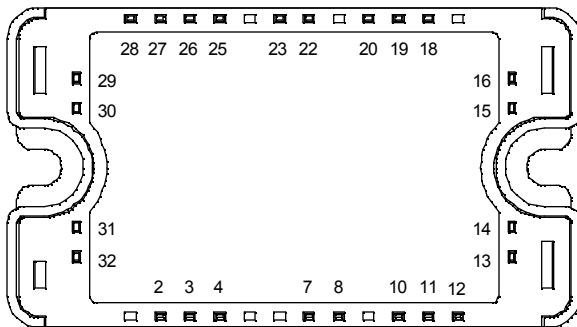
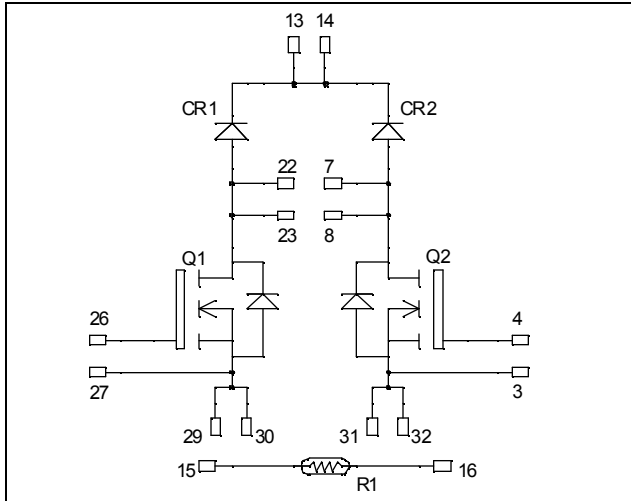


## Dual boost chopper Super Junction MOSFET Power Module

$$V_{DSS} = 600V$$

$$R_{DSon} = 35m\Omega \text{ max @ } T_j = 25^\circ C$$

$$I_D = 72A \text{ @ } T_c = 25^\circ C$$



All multiple inputs and outputs must be shorted together  
 Example: 13/14 ; 29/30 ; 22/23 ...

### Application

- AC and DC motor control
- Switched Mode Power Supplies
- Power Factor Correction

### Features

- **COOLMOS** Power Semiconductors
  - Ultra low  $R_{DSon}$
  - Low Miller capacitance
  - Ultra low gate charge
  - Avalanche energy rated
  - Very rugged
- Kelvin source for easy drive
- Very low stray inductance
  - Symmetrical design
- Internal thermistor for temperature monitoring
- High level of integration

### Benefits

- Outstanding performance at high frequency operation
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- Solderable terminals both for power and signal for easy PCB mounting
- Low profile
- Each leg can be easily paralleled to achieve a single boost of twice the current capability
- RoHS Compliant

### Absolute maximum ratings

| Symbol     | Parameter                                         | Max ratings        | Unit      |
|------------|---------------------------------------------------|--------------------|-----------|
| $V_{DSS}$  | Drain - Source Breakdown Voltage                  | 600                | V         |
| $I_D$      | Continuous Drain Current                          | $T_c = 25^\circ C$ | A         |
|            |                                                   | $T_c = 80^\circ C$ |           |
| $I_{DM}$   | Pulsed Drain current                              | 288                |           |
| $V_{GS}$   | Gate - Source Voltage                             | $\pm 20$           | V         |
| $R_{DSon}$ | Drain - Source ON Resistance                      | 35                 | $m\Omega$ |
| $P_D$      | Maximum Power Dissipation                         | $T_c = 25^\circ C$ | W         |
| $I_{AR}$   | Avalanche current (repetitive and non repetitive) | 20                 | A         |
| $E_{AR}$   | Repetitive Avalanche Energy                       | 1                  | mJ        |
| $E_{AS}$   | Single Pulse Avalanche Energy                     | 1800               |           |



**CAUTION:** These Devices are sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed. See application note APT0502 on [www.microsemi.com](http://www.microsemi.com)

All ratings @  $T_j = 25^\circ\text{C}$  unless otherwise specified

## Electrical Characteristics

| Symbol       | Characteristic                  | Test Conditions                 | Min | Typ | Max       | Unit      |
|--------------|---------------------------------|---------------------------------|-----|-----|-----------|-----------|
| $I_{DSS}$    | Zero Gate Voltage Drain Current | $V_{GS} = 0V, V_{DS} = 600V$    |     |     | 40        | $\mu A$   |
|              |                                 | $T_j = 125^\circ\text{C}$       |     |     | 375       |           |
| $R_{DS(on)}$ | Drain – Source on Resistance    | $V_{GS} = 10V, I_D = 72A$       |     |     | 35        | $m\Omega$ |
| $V_{GS(th)}$ | Gate Threshold Voltage          | $V_{GS} = V_{DS}, I_D = 5.4mA$  | 2.1 | 3   | 3.9       | V         |
| $I_{GSS}$    | Gate – Source Leakage Current   | $V_{GS} = \pm 20V, V_{DS} = 0V$ |     |     | $\pm 150$ | nA        |

## Dynamic Characteristics

| Symbol       | Characteristic               | Test Conditions                                                                                                                       | Min | Typ  | Max | Unit    |
|--------------|------------------------------|---------------------------------------------------------------------------------------------------------------------------------------|-----|------|-----|---------|
| $C_{iss}$    | Input Capacitance            | $V_{GS} = 0V$                                                                                                                         |     | 14   |     | nF      |
| $C_{oss}$    | Output Capacitance           | $V_{DS} = 25V$                                                                                                                        |     | 5.13 |     |         |
| $C_{rss}$    | Reverse Transfer Capacitance | $f = 1MHz$                                                                                                                            |     | 0.42 |     |         |
| $Q_g$        | Total gate Charge            | $V_{GS} = 10V$                                                                                                                        |     | 518  |     | nC      |
| $Q_{gs}$     | Gate – Source Charge         | $V_{Bus} = 300V$                                                                                                                      |     | 58   |     |         |
| $Q_{gd}$     | Gate – Drain Charge          | $I_D = 72A$                                                                                                                           |     | 222  |     |         |
| $T_{d(on)}$  | Turn-on Delay Time           | <b>Inductive Switching @ <math>125^\circ\text{C}</math></b><br>$V_{GS} = 15V$<br>$V_{Bus} = 400V$<br>$I_D = 72A$<br>$R_G = 2.5\Omega$ |     | 21   |     | ns      |
| $T_r$        | Rise Time                    |                                                                                                                                       |     | 30   |     |         |
| $T_{d(off)}$ | Turn-off Delay Time          |                                                                                                                                       |     | 283  |     |         |
| $T_f$        | Fall Time                    |                                                                                                                                       |     | 84   |     |         |
| $E_{on}$     | Turn-on Switching Energy     | <b>Inductive switching @ <math>25^\circ\text{C}</math></b><br>$V_{GS} = 15V, V_{Bus} = 400V$<br>$I_D = 72A, R_G = 2.5\Omega$          |     | 1340 |     | $\mu J$ |
| $E_{off}$    | Turn-off Switching Energy    |                                                                                                                                       |     | 1960 |     |         |
| $E_{on}$     | Turn-on Switching Energy     | <b>Inductive switching @ <math>125^\circ\text{C}</math></b><br>$V_{GS} = 15V, V_{Bus} = 400V$<br>$I_D = 72A, R_G = 2.5\Omega$         |     | 2192 |     | $\mu J$ |
| $E_{off}$    | Turn-off Switching Energy    |                                                                                                                                       |     | 2412 |     |         |

## Chopper diode ratings and characteristics

| Symbol    | Characteristic                          | Test Conditions                                      | Min                       | Typ  | Max | Unit    |
|-----------|-----------------------------------------|------------------------------------------------------|---------------------------|------|-----|---------|
| $V_{RRM}$ | Maximum Peak Repetitive Reverse Voltage |                                                      | 600                       |      |     | V       |
| $I_{RM}$  | Maximum Reverse Leakage Current         | $V_R = 600V$                                         | $T_j = 25^\circ\text{C}$  |      | 350 | $\mu A$ |
|           |                                         |                                                      | $T_j = 125^\circ\text{C}$ |      | 600 |         |
| $I_F$     | DC Forward Current                      |                                                      |                           | 80   |     | A       |
| $V_F$     | Diode Forward Voltage                   | $I_F = 80A$<br>$V_{GE} = 0V$                         | $T_j = 25^\circ\text{C}$  | 1.45 |     | V       |
|           |                                         |                                                      | $T_j = 125^\circ\text{C}$ | 1.35 |     |         |
| $t_{rr}$  | Reverse Recovery Time                   | $I_F = 80A$<br>$V_R = 300V$<br>$di/dt = 4500A/\mu s$ | $T_j = 25^\circ\text{C}$  | 95   |     | ns      |
|           |                                         |                                                      | $T_j = 125^\circ\text{C}$ | 115  |     |         |
| $Q_{rr}$  | Reverse Recovery Charge                 |                                                      | $T_j = 25^\circ\text{C}$  | 5.2  |     | $\mu C$ |
|           |                                         |                                                      | $T_j = 125^\circ\text{C}$ | 8    |     |         |

## Thermal and package characteristics

| Symbol            | Characteristic                                                            |             |    | Min        | Typ | Max | Unit |
|-------------------|---------------------------------------------------------------------------|-------------|----|------------|-----|-----|------|
| R <sub>thJC</sub> | Junction to Case Thermal Resistance                                       |             |    | Transistor |     | 0.3 | °C/W |
|                   |                                                                           |             |    | Diode      |     | 0.8 |      |
| V <sub>ISOL</sub> | RMS Isolation Voltage, any terminal to case t =1 min, I isol<1mA, 50/60Hz |             |    | 2500       |     |     | V    |
| T <sub>J</sub>    | Operating junction temperature range                                      |             |    | -40        |     | 150 | °C   |
| T <sub>STG</sub>  | Storage Temperature Range                                                 |             |    | -40        |     | 125 |      |
| T <sub>C</sub>    | Operating Case Temperature                                                |             |    | -40        |     | 100 |      |
| Torque            | Mounting torque                                                           | To heatsink | M4 | 2.5        |     | 4.7 | N.m  |
| Wt                | Package Weight                                                            |             |    |            |     | 110 | g    |

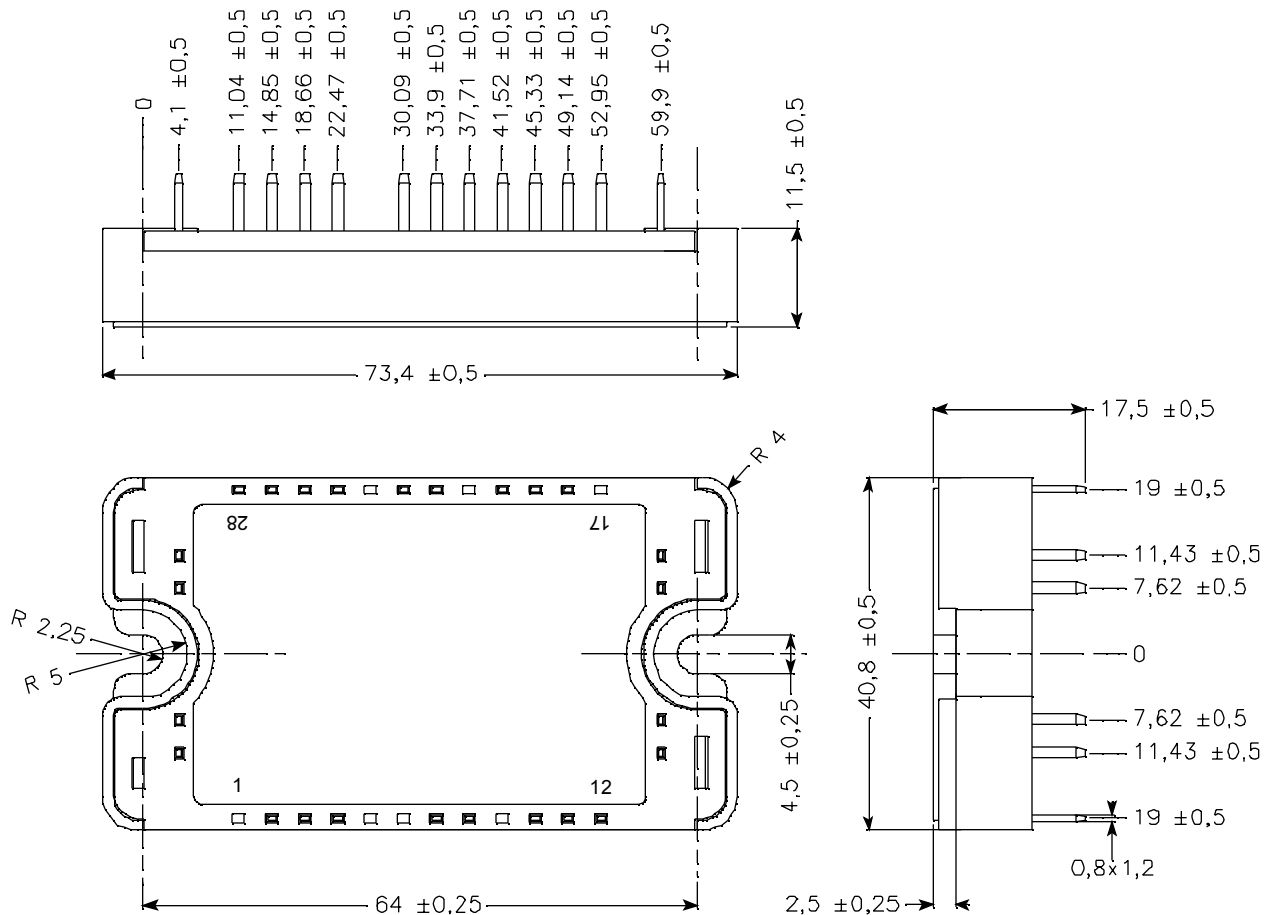
## Temperature sensor NTC (see application note APT0406 on www.microsemi.com for more information).

| Symbol             | Characteristic             | Min | Typ  | Max | Unit |
|--------------------|----------------------------|-----|------|-----|------|
| R <sub>25</sub>    | Resistance @ 25°C          |     | 50   |     | kΩ   |
| B <sub>25/85</sub> | T <sub>25</sub> = 298.15 K |     | 3952 |     | K    |

$$R_T = \frac{R_{25}}{\exp \left[ B_{25/85} \left( \frac{1}{T_{25}} - \frac{1}{T} \right) \right]}$$

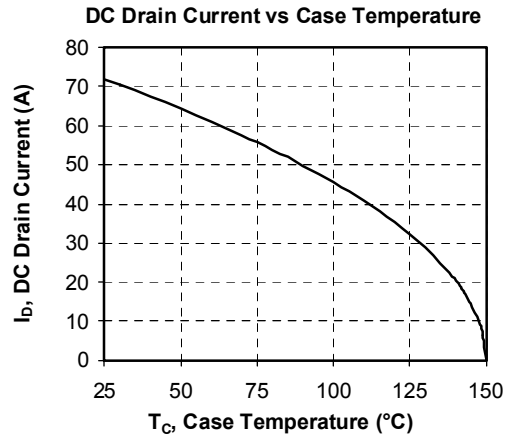
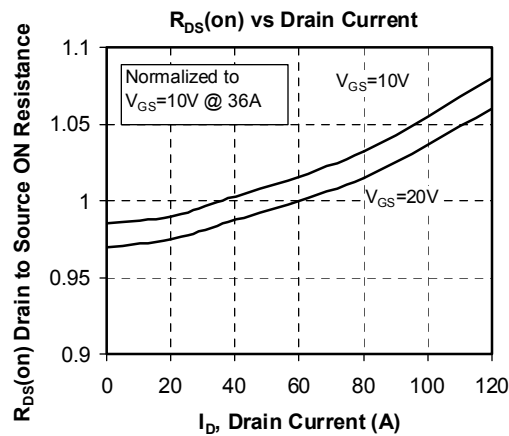
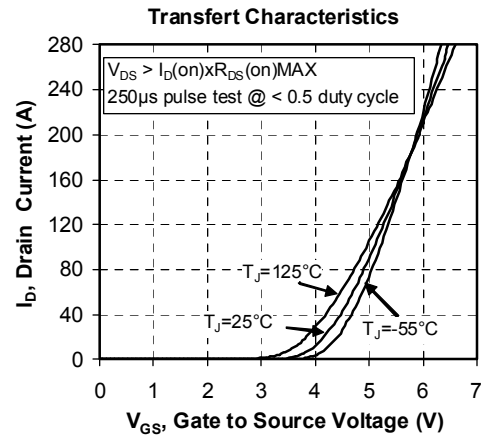
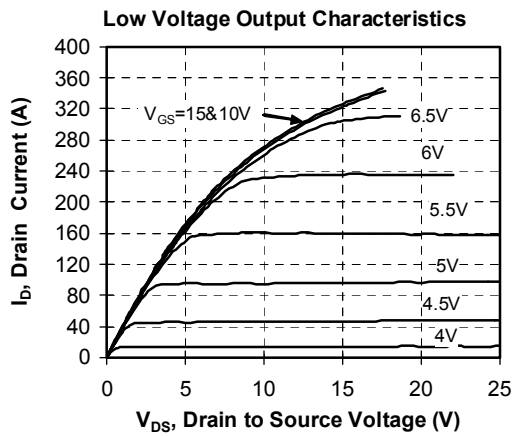
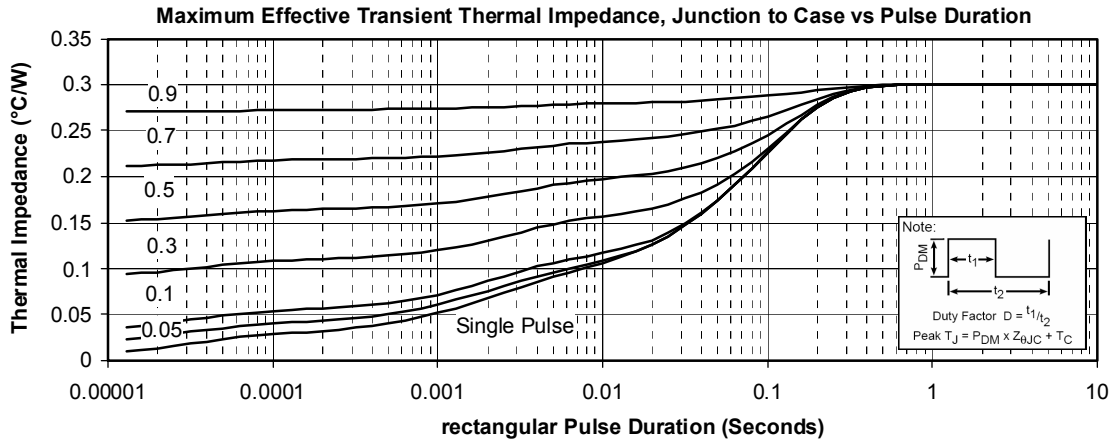
T: Thermistor temperature  
 R<sub>T</sub>: Thermistor value at T

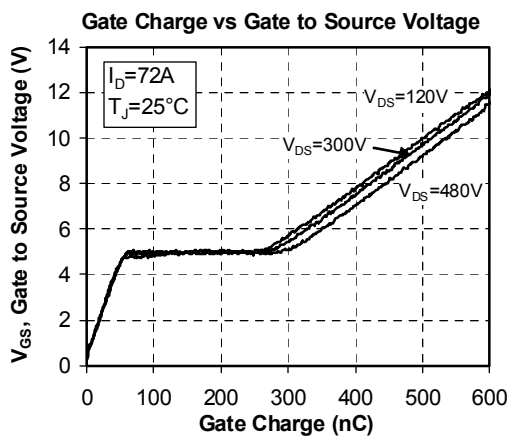
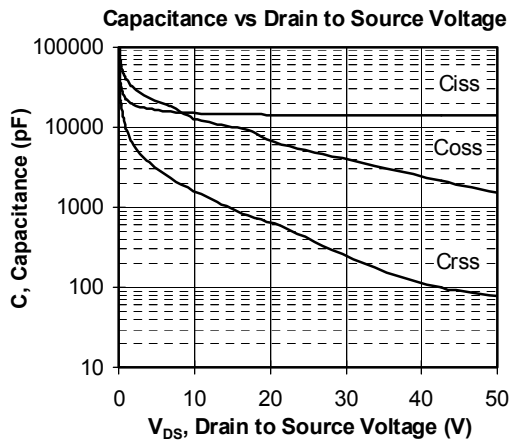
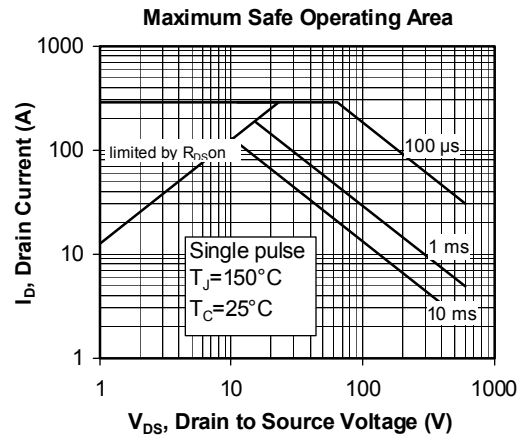
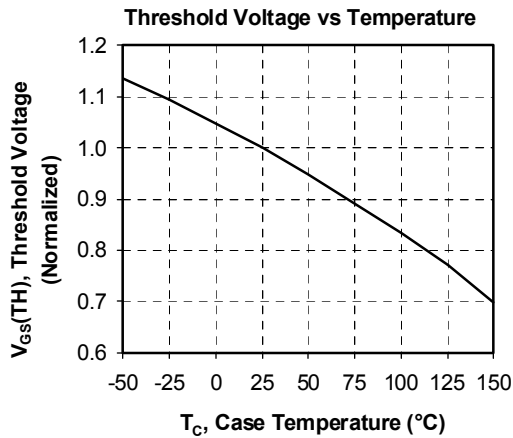
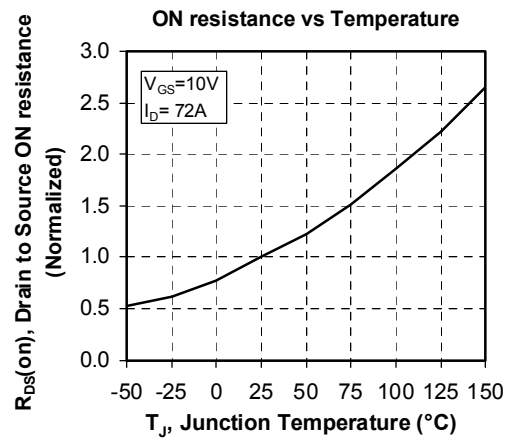
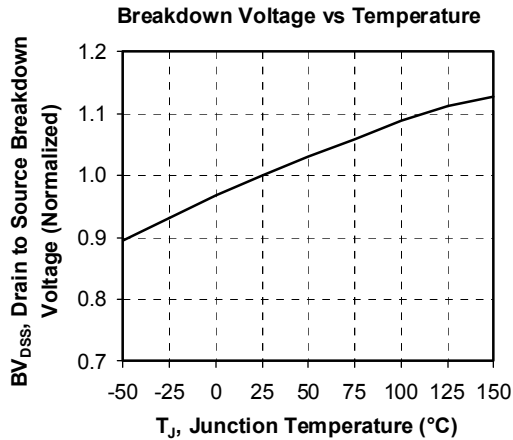
## SP3 Package outline (dimensions in mm)

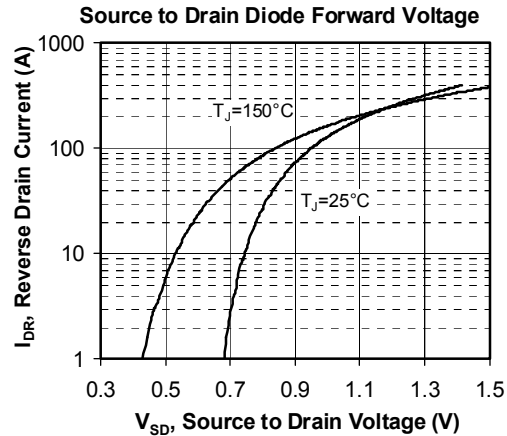
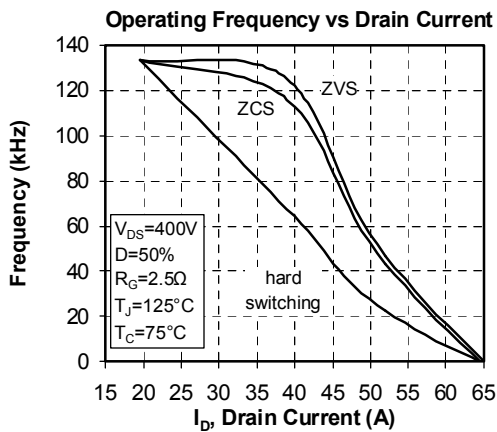
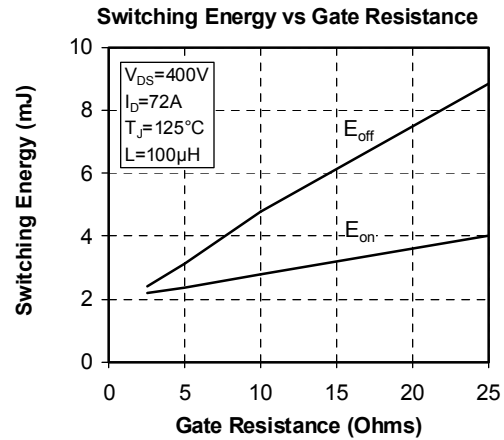
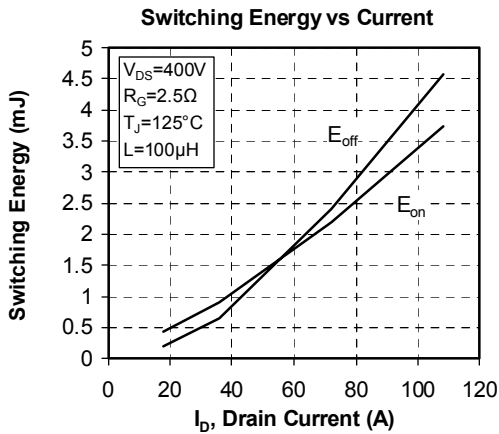
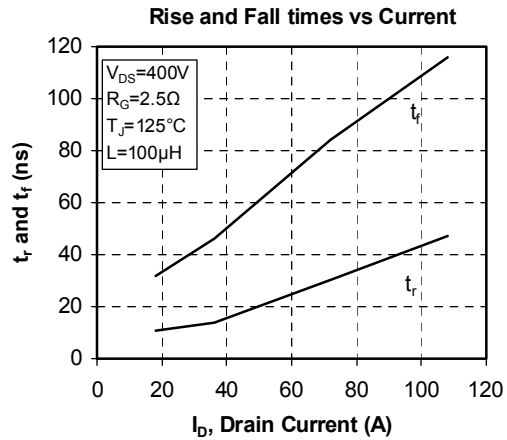
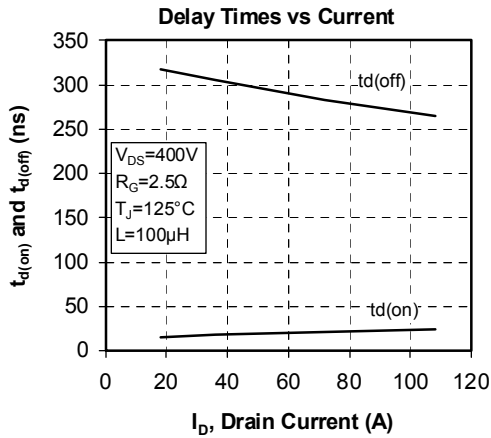


See application note 1901 - Mounting Instructions for SP3 Power Modules on [www.microsemi.com](http://www.microsemi.com)

## Typical Performance Curve







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